

Patent Claims

1. A surface paneling module

5 • having at least one electrical power supply connection,

 • having at least one data transmission interface,

 • having at least one processor unit which is coupled to the electrical power supply connection and to the data transmission interface,

10 • in which the processor unit is designed such that electronic messages are interchanged between the processor unit and a processor unit for an adjacent surface paneling module, which is coupled to the surface paneling module, in order to determine the respective distance of a processor unit from a reference position

15 • with each message containing distance information which indicates the distance of the surface paneling module of a processor unit which is sending the message or the distance of the surface paneling module of a processor unit which is receiving the message from the reference position, and

20 • with the processor unit being designed such that the actual distance to the reference position can be determined or can be stored from the distance information in a received message.

2. The surface paneling module as claimed in claim 1,

30 having a plug connector in which the electrical power supply connection and the data transmission interface are integrated.

3. The surface paneling module as claimed in claim 1

35 or 2, having at least one electrical power line and at least one data line, wherein the processor unit is coupled to the electrical power supply connection by means of the electrical power line, and is coupled to

the data transmission interface by means of the data line.

4. The surface paneling module as claimed in one of
5 claims 1 to 3,

designed as one of the following modules:

- wall paneling module, or
- floor paneling module, or
- ceiling paneling module.

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5. The surface paneling module as claimed in one of
claims 1 to 3,

designed as

- a tile, or
- a wall tile, or
- a parquet flooring element, or
- a laminate element.

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6. The surface paneling module as claimed in one of
claims 1 to 5,

having at least one sensor which is coupled to the
processor unit.

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7. The surface paneling module as claimed in one of
claims 1 to 6,

having at least one of the following elements, which is
coupled to the processor unit,

- imaging element, or
- sound wave production element, or
- vibration production element.

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8. A surface paneling module arrangement having two
or more surface paneling modules as claimed in one of
claims 1 to 7, which are coupled to one another by
35 means of the electrical power supply connection and the
data transmission interface.

9. A method for determining a distance from surface

paneling modules of the surface paneling module arrangement as claimed in claim 1 to at least one reference position, with electronic messages being interchanged between processor units of mutually adjacent surface paneling modules,

- in which a first message is produced by a processor unit of a first surface paneling module, with the first message containing first distance information which contains the distance of the first surface paneling module or the distance of a second surface paneling module which receives the first message from the reference position,
- in which the first message is sent from the processor unit of the first surface paneling module to the processor unit of the second surface paneling module,
- in which the distance of the processor unit of the second surface paneling module from the reference position is determined or stored as a function of the distance information,
- in which the processor unit of the second surface paneling module produces a second message which contains second distance information which contains the distance of the second surface paneling module or the distance of a third surface paneling module which receives the second message, from the reference position,
- in which the second message is sent from the processor unit of the second surface paneling module to the processor unit of the third surface paneling module,
- in which the distance of the third surface paneling module from the reference position is determined or stored as a function of the second distance information,
- in which the method steps are carried out for all the surface paneling modules in the surface paneling module arrangement.

10. The method as claimed in claim 9,
in which, before the determination of the distance of
the surface paneling modules from the reference
5 position, the physical positions of the surface paneling module
paneling modules within the surface paneling module
arrangement are determined in that, on the basis of a
surface paneling module at an introduction point of the
surface paneling module arrangement, position
10 determination messages which have at least one row
parameter z and one column parameter s (which contains
the row number or column number, respectively, of the
processor unit sending the message or the row number or
the column number, respectively, of the processor unit
15 receiving the message within the surface paneling
module arrangement) are in each case transmitted to
processor units of adjacent surface paneling modules,
and the respective processor unit carries out the
following steps:

20 • if the row parameter in the received message is
greater than the previously stored row number of
the processor unit, then the processor unit's own
row number is allocated the row parameter value z
of the received message,

25 • if the column parameter in the received message is
greater than the processor unit's own column
number, then the stored column number is allocated
the row parameter value of the received message,

30 • if its own row number and/or its own column number
have/has been changed on the basis of the method
steps described above, then new position
measurement messages are produced with new row
parameters and new column parameters, which each
contain the row number and the column number of
35 the processor unit sending the message or the row
number and the column number of the processor unit
receiving the message, and these are transmitted
to a processor unit of a respective adjacent

surface paneling module.

11. The method as claimed in claim 9 or 10,

- in which, in an iterative method, the processor unit of the surface paneling module's own distance value is changed if the previously stored distance value is greater than the received distance value (increased by a predetermined value) in the respectively received message, and

10 • in which, in the situation where a processor unit of a surface paneling module changes its own distance value, this produces a distance measurement message and sends this to processor units of adjacent surface paneling modules, with the distance measurement message in each case containing its own distance as distance information or the distance value which the receiving processor unit has from the portal processor.

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12. The method as claimed in claim 11,

in which the distance value has a value which is greater by a predetermined value than its own distance value.

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13. A processor arrangement,

- having at least one interface processor which provides a message interface for the processor arrangement,

30 • having a large number of processors, with, at least in some cases, only those processors which are arranged physically directly adjacent to one another being coupled to one another in order to interchange electronic messages,

35 • in which each processor of the large number of processors is allocated a sensor and/or an actuator and is coupled to the respective processor with sensor data and/or actuator data

- being transmitted in the electronic messages from and/or to the interface processor,
and
- with the processors which are arranged physically directly adjacent to one another at least in some cases being coupled to one another in accordance with a regular coupling topology whose degree is greater than unity.
- 10 14. The processor arrangement as claimed in claim 13, in which the processors which are arranged physically directly adjacent to one another are coupled to one another in accordance with a regular bus coupling topology.
- 15 15. The processor arrangement as claimed in claim 13, in which the processors which are arranged physically directly adjacent to one another are coupled to one another in accordance with a regular ring coupling topology.
- 20 16. The processor arrangement as claimed in claim 14 or 15, in which the regular bus coupling topology is designed in accordance with one of the following communication interface standards:
- serial parallel interface,
 - controller area network interface, or
 - I²C interface.
- 30 17. The processor arrangement as claimed in one of claims 13 to 16, in which the processors are arranged in rows and columns in the form of a matrix.
- 35 18. A textile fabric structure having a processor arrangement as claimed in one of claims 13 to 17,
 - in which the processors and/or sensors and/or

actuators are arranged in the textile fabric structure,

- having electrically conductive threads which couple the processors to one another,
- 5 • having conductive data transmission threads which couple the processors to one another, and
- having electrically non-conductive threads.

19. The textile fabric structure as claimed in
10 claim 18,

in which the electrically conductive threads are designed such that they can be used to supply power to the two or more processors and/or sensors and/or actuators.

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20. The textile fabric structure as claimed in
claim 18 or 19,

in which the conductive data transmission threads are electrically conductive.

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21. The textile fabric structure as claimed in
claim 18 or 19,

in which the conductive data transmission threads are optically conductive.

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22. The textile fabric structure as claimed in one of
claims 18 to 21,

in which the actuator is designed as at least one of
the following elements:

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- imaging element, or
- sound wave production element, or
- vibration production element.

23. A surface paneling structure,

35 in which surface paneling is fixed on a textile fabric structure as claimed in one of claims 6 to 10.

24. The surface paneling structure as claimed in

claim 23,

in which the surface paneling is adhesively bonded and/or laminated and/or vulcanized onto the textile fabric structure.

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25. The surface paneling structure as claimed in claim 23 or 24,

in which the surface paneling structure is designed as

- wall paneling structure, or
- floor paneling structure, or
- ceiling paneling structure.

10 26. The surface paneling structure as claimed in one of claims 23 to 25,

15 in which a textile layer through which electrically conductive wires pass uniformly is applied at least over subareas of the textile fabric structure.